Sir:

02/08/02Transmitted Herewith for filing is the Patent Application of:

Inventor: CHEW-HOE ANG, ENG HUA LIM, RANDALL CHA, JIA-ZHEN ZHENG, ELGIN QUEK, MEI BHE

ZHOU, DANIEL YEN

For: A METHOD TO PATTERN SMALL FEATURES BY USING A RE-FLOWABLE HARD MASK

Enclos	ed are:	•					
x 2 sheets of drawing(s) - formal.							
\square	An assig	nment of the i	nvention to	Chartered Semicon	nductor Manufa	cturing Ltd.	
	An assoc	iate power of	attorney	Applicant of	Applicant claims small entity status		
	Request	& Certificatio	n under 35 U	SC 122(b)(2)(b)(:	i)		
he fi	ling fee	has been calc	ulated as sh	own below:			
일 일		(Col. 1)	(Col. 2)	OTHER THAN A	SMALL ENTITY	1	
FOR:		NO. FILED	NO. EXTRA	RATE	FEE		
BASIC	FEE	><	$\geq \leq$		\$ 740,	·	
TOTAL	CLAIMS	36 -20=	16	x 18 =	\$ 288.		
INDE	CLAIMS	3 -3=	0	x 84 = '	\$ 0.	·	
MULTIPLE DEPENDENT CLAIM PRESENTED + 260 =							
SUB TOTAL \$ 1,028.							
				ASSIGNMENT	\$40.		
			į	TOTAL	\$ 1,068.		
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x Any additional filing fees required under 37 CFR \$1.16.							
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Respectfylly submitted,							
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